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SPECIFICATION

CUSTOM	ER :						
MODULE	NO.:	WF320234A-TXI#					
APPROVI	ED BY:						
(FOR CUSTOME	R USE ONLY)						
		PCB	VERSION:		DATA:		
SALES BY	APPROVED	BY	CHECKED	BY	PREPARED BY		
			_				



MODLE NO :

REC	ORDS OF REV		DOC. FIRST ISSUE
VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2006.09.13		First issue

Winstar reserves the right to change products and specifications without notice at any time.

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1. Module Classification Information

W F 320234 A- TXI #

Brand: WINSTAR DISPLAY CORPORATION

Display Type : H→Character Type, G→Graphic Type F→TFT Type

Display Font: 320*234 Dots

Model serials no.

Backlight Type: $N\rightarrow$ Without backlight $A\rightarrow$ LED, Amber

 $B \rightarrow EL$, Blue green $R \rightarrow LED$, Red $D \rightarrow EL$, Green $O \rightarrow LED$, Orange $W \rightarrow EL$, White $G \rightarrow LED$, Green $F \rightarrow CCFL$, White $T \rightarrow LED$, White

Y→LED, Yellow Green

LCD Mode : $B \rightarrow TN$ Positive, Gray $T \rightarrow FSTN$ Negative

 $N \rightarrow TN$ Negative, $X \rightarrow TFT$ Negative

G→STN Positive, Gray M→STN Negative, Blue

Y→STN Positive, Yellow Green

F→FSTN Positive

LCD Polarize A→Reflective, N.T, 6:00 H→Transflective, W.T,6:00

Type/ Temperature D→Reflective, N.T, 12:00 K→Transflective, W.T,12:00 range/ View G→Reflective, W. T, 6:00 C→Transmissive, N.T,6:00

direction $J\rightarrow$ Reflective, W. T, 12:00 $F\rightarrow$ Transmissive, N.T,12:00

B→Transflective, N.T,6:00 I→Transmissive, W. T, 6:00

E→Transflective, N.T.12:00 L→Transmissive, W.T,12:00

Special Code

2.Precautions in use of LCD Modules

2.1. Safety

Liquid crystal is poisonous. Do not put it in your mouth. If liquid crystal touches your skin or clothes, wash it off immediately by using soap and water.

2.2. Handling

- 1. The LCD panel is plate glass. Do not subject the panel to mechanical shock or to excessive force on its surface.
- 2. The polarizer attached to the display is easily damaged. Please handle it carefully to avoid scratch or other damages.
- 3. To avoid contamination on the display surface, do not touch the module surface with bare hands.
- 4. Keep a space so that the LCD panels do not touch other components.
- 5. Put cover board such as acrylic board on the surface of LCD panel to protect panel from damages.
- 6. Transparent electrodes may be disconnected if you use the LCD panel under environmental conditions where the condensation of dew occurs.
- 7. Do not leave module in direct sunlight to avoid malfunction of the ICs.

2.3. Static Electricity

- 1. Be sure to ground module before turning on power or operating module.
- 2. Do not apply voltage which exceeds the absolute maximum rating value.

2.4. Storage

- 1. Store the module in a dark room where must keep at $+25\pm10\Box$ and 65%RH or less.
- 2. Do not store the module in surroundings containing organic solvent or corrosive gas.
- 3. Store the module in an anti-electrostatic container or bag.

2.5. Cleaning

- 1. Do not wipe the polarizer with dry cloth. It might cause scratch.
- 2. Only use a soft sloth with IPA to wipe the polarizer, other chemicals might permanent damage to the polarizer.

3.General Specification

Item	Dimension	Unit
Dot Matrix	320 x RGBx234(TFT)	dots
Module dimension	126.5 x 100.0 x 5.7	mm
Active area	113.28 x 84.708	mm
Dot pitch	0.118 x 0.362	mm
Driving IC package	COG	
Display number of colors	Full color	
LCD type	TFT, Negative, Transmissive	
View direction	6 o'clock	
Backlight Type	LED White	

^{*}Epose the IC number blaze (Luminosity over than 1 cd) when using the LCM may cause IC operating failure.

4.Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	T_{OP}	-30	_	+80	$^{\circ}\!\mathbb{C}$
Storage Temperature	T_{ST}	-30	_	+80	$^{\circ}\!\mathbb{C}$
	$ m V_{GH}$	-0.3		18	V
Power Supply Voltage	$ m V_{GL}$	-15	_	0.3	V
	VCC	-0.3	_	7.0	V
	DDVDH	-0.3	_	7.0	V

^{*}Color tone slight changed by temperature and driving voltage.

5.Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
	VCC	_	4.8	5.0	5.2	V
Supply Voltage For Logic	$V_{ m GH}$	Ta=25°℃	14.3	15.0	15.7	V
	$V_{ m GL}$	Ta=25°C	-10.5	-10	-9.5	V
Input High Volt.	V_{IH}	_	0.7 V _{CC}	_	V_{CC}	V
Input Low Volt.	V_{IL}	_	0	_	0.3Vcc	V
Supply Current	I_{cc}		_	10.0	20.0	mA (*NOTE1)

^{*}NOTE1:MIN. and MAX. Voltage is specified ac the voltage within the condition Temperature rang -30°C ~80°C

Typ. Voltage is specified as module driving condition : Ta=25 $^{\circ}$ C ,Vop at Optimum Contrast

6.Optical Characteristics

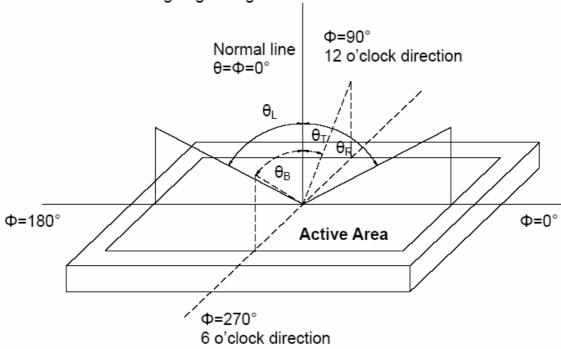
Item	Symbol	mbol Condition		Values			Remar	
item	Symbol	Condition	Min.	Тур.	Max.	Unit	k	
	θ_{L}	Φ=180°(9 o'clock)	55	65	-			
Viewing angle	θ_R	Φ=0°(3 o'clock)	55	65	-	dograa	Note 1	
(CR≥10)	θΤ	Φ=90°(12 o'clock)	35	45	-	degree	Note 1	
	θΒ	Φ=270°(6 o'clock)	55	65	-			
Doctores time	Ton		-	15	30	msec	Note 3	
Response time	T _{OFF}		-	20	40	msec	Note 3	
Contrast ratio	CR		250	300	-	-	Note 4	
	Wx	Normal θ=Φ=0°	0.25	0.30	0.35	-	Note 2	
Color chromaticity	W _Y		0.28	0.33	0.38	-	Note 5 Note 6	
Luminance	L		200	250	-	cd/m²	Note 6	
Luminance uniformity	Yu		70	75	-	-	Note 7	

Test Conditions:

- 1. V_{CC} =5V, AV_{DD} =5V, I_L =20mA (Backlight current), the ambient temperature is 25 $^{\circ}$ C. 2. The test systems refer to Note 2.

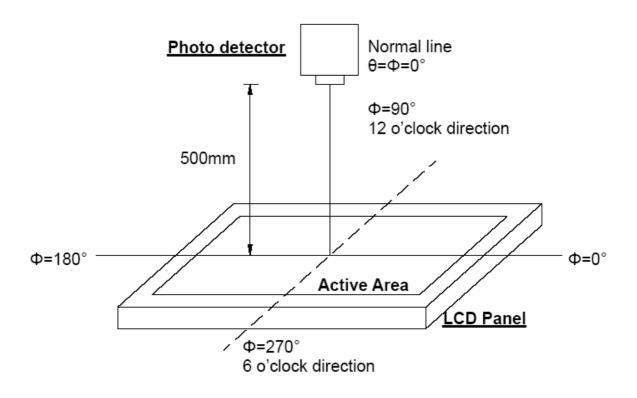
6.1 Definition of optical characteristics

Note 1: Definition of viewing angle range



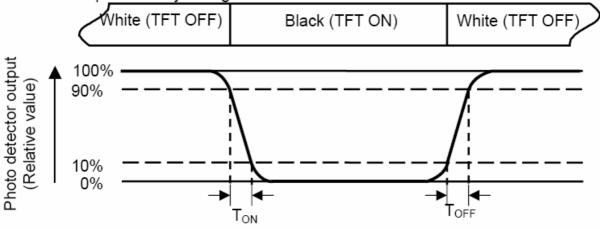
Note 2: Definition of optical measurement system.

The optical characteristics should be measured in dark room. After 30 minutes operation, the optical properties are measured at the center point of the LCD screen. (Response time is measured by Photo detector TOPCON BM-7, other items are measured by BM-5A/Field of view: 1° /Height: 500mm.)



Note 3: Definition of Response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (T_{ON}) is the time between photo detector output intensity changed from 90% to 10%. And fall time (T_{OFF}) is the time between photo detector output intensity changed from 10% to 90%.



Note 4: Definition of contrast ratio

White
$$V_i = V_{i50\%} \pm 1.5 \text{ V}$$

Black $V_i = V_{i50\%} \mp 2.0 \text{ V}$

"±" means that the analog input signal swings in phase with V_{COM} signal.

V_{i50%}: The analog input voltage when transmission is 50%

The 100% transmission is defined as the transmission of LCD panel when all the input terminals of module are electrically opened.

Note 5: Definition of color chromaticity (CIE1931)

Color coordinates measured at center point of LCD.

Note 6: All input terminals LCD panel must be ground while measuring the center area of the panel.

[&]quot;∓" means that the analog input signal swings out of phase with V_{COM} signal.

Note 7: Definition of Luminance Uniformity

Luminance Uniformity (Yu) =
$$\frac{B_{min}}{B_{max}}$$

L-----Active area length W----- Active area width

 \mathbf{B}_{max} : The measured maximum luminance of all measurement position. \mathbf{B}_{min} : The measured minimum luminance of all measurement position.

7.Interface Pin Function

Pin No.	Symbol	I/O	Function	Remark
1	GND	-	Ground	
2	Vcc	I	Supply voltage for logic control circuit scan driver	
3	V_{GL}	I	Negative power for scan driver	
4	V _{GH}	I	Positive power for scan driver	
5	STVR	I/O	Vertical start pulse	Note 1
6	STVL	I/O	Vertical start pulse	Note 1
7	CKV	I	Shift clock input for scan driver	
8	U/D	I	UP/DOWN scan control input	Note 1, 2
9	OEV	I	Output enable control for scan driver	
10	V _{COM}	I	Common electrode driving signal	
11	V _{COM}	I	Common electrode driving signal	
12	L/R	I	LEFT/RIGHT scan control input	Note 1, 2
13	MOD	I	Sequential sampling and simultaneous sampling setting	
14	OEH	I	Output enable control for data driver	
15	STHL	I/O	Start pulse for horizontal scan line	Note 1
16	STHR	I/O	Start pulse for horizontal scan line	Note 1
17	СРН3	I	Sampling and shifting clock pulse for data driver	
18	CPH2	I	Sampling and shifting clock pulse for data driver	
19	CPH1	I	Sampling and shifting clock pulse for data driver	
20	V _{CC}	I	Supply voltage for logic control circuit scan driver	

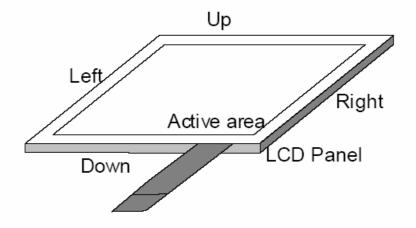
21	GND	-	Ground	
22	V _R	I	Alternated video signal (Red)	
23	V _G	I	Alternated video signal (Green)	
24	V _B	I	Alternated video signal (Blue)	
25	AV _{DD}	I	Supply voltage for analog circuit	
26	AV _{SS}	I	Ground for analog circuit	

I: input, O: output, P: Power

Note 1: Selection of scanning mode

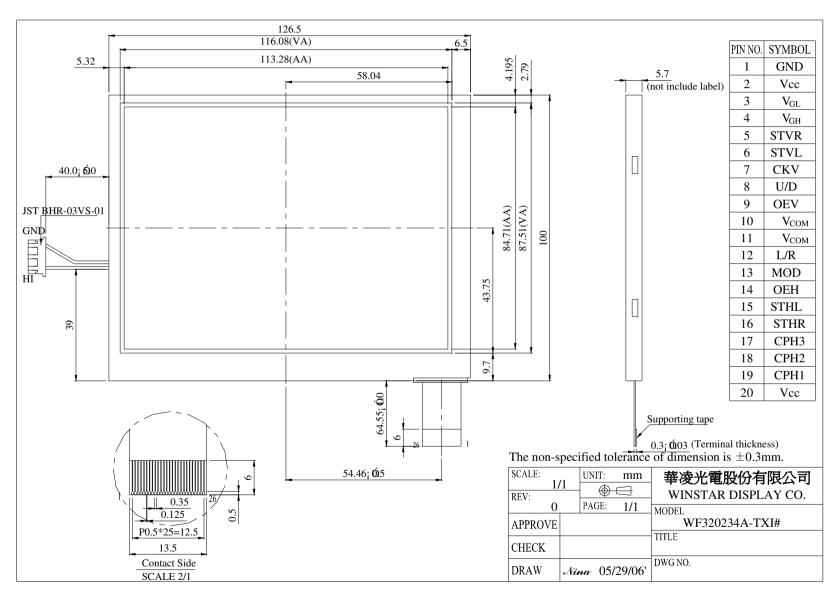
Setting of scan control input		IN/OUT	state for s	tart pulse	Scanning direction	
U/D	L/R	STVR	STVL	STHR	STHL	
GND	Vcc	0	I	0	I	Up to down, left to right
Vcc	GND	1	0	1	0	Down to up, right to left
GND	GND	0	I	I	0	Up to down, right to left
V _{CC}	V _{cc}	1	0	0	1	Down to up, left to right

Note 2: Definition of scanning direction. Refer to the figure as below:



Note 3: MOD=H: Simultaneous sampling.
MOD=L: Sequential sampling.
Please set CPH2 and CPH3 to GND when MOD=H.

8.Contour Drawing



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9. Timing Characteristics

9.1 AC Characteristics

ltem	Sumbol		Values	Unit	Remark		
item	Symbol	Min.	Тур.	Мах.	Onit	Kemark	
Rising time	tr	-	-	60	ns	Note 1	
Falling time	t _f	-	1	60	ns	Note 1	
High and low level pulse width	t _{CPH}	150	154	158	ns	CPH1~CPH3	
CPH pulse duty	t _{cwн}	40	50	60	%	CPH1~CPH3	
	t _{C12}						
CPH pulse delay	t _{C23}	30	t _{CPH} /3	t _{CPH} /2	ns	CPH1~CPH3	
	t _{C31}						
STH setup time	t _{suн}	20	-	-	ns	STHR, STHL	
STH hold time	t _{HDH}	20	-	-	ns	STHR, STHL	
STH pulse width	t _{sтн}	-	1	-	t _{CPH}	STHR, STHL	
STH period	t _H	61.5	63.5	65.5	μs	STHR, STHL	
OEH pulse width	t _{OEH}	1	7	-	μs		
Sample and hold disable time	t _{DIS1}	-	55		μs		
OEV pulse width	t _{OEV}	-	27		μs		
CKV pulse width	t _{CKV}	16	-	40	μs		
Clean enable time	t _{DIS2}	-	16		μs		
Horizontal display start	t _{SH}	-	0	-	t _{CPH} /3		
Horizontal display timing range	t _{DH}	-	960	-	t _{CPH} /3		
STV setup time	t _{suv}	400	-	-	ns	STVL, STVR	
STV hold time	t _{HDV}	400	-	-	ns	STVL, STVR	

				FAG	0	123
STV pulse width	t _{STV}	-	-	1	t _H	STVL, STVR
Horizontal lines per field	t _V	256	262.5	268	t _H	Note 2
Vertical display start	t _{sv}	-	3	-	t _H	
Vertical display timing range	t _{DV}	-	234	ı	t _H	
VCOM rising time	t _{rCOM}	-	-	5	μs	
VCOM falling time	t _{fCOM}	-	-	5	μs	
VCOM delay time	t _{DCOM}	-	-	3	μs	
RGB delay time	t _{DRGB}	-	-	1	μs	

Note 1: For all of the logic signals Note 2: Please don't use odd horizontal lines to drive LCD panel for both odd and even field simultaneously.

Timing diagram

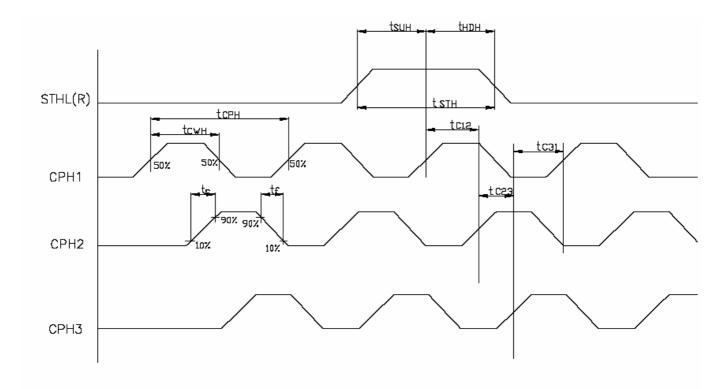


Fig.1 Sampling clock timing

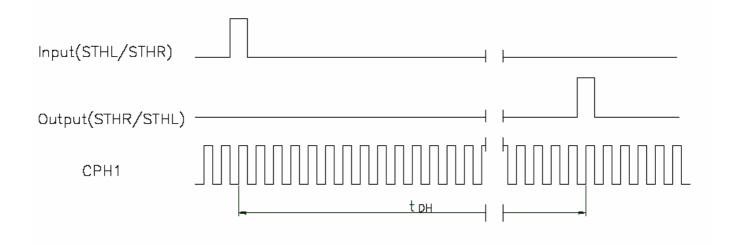


Fig.2 Horizontal display timing range

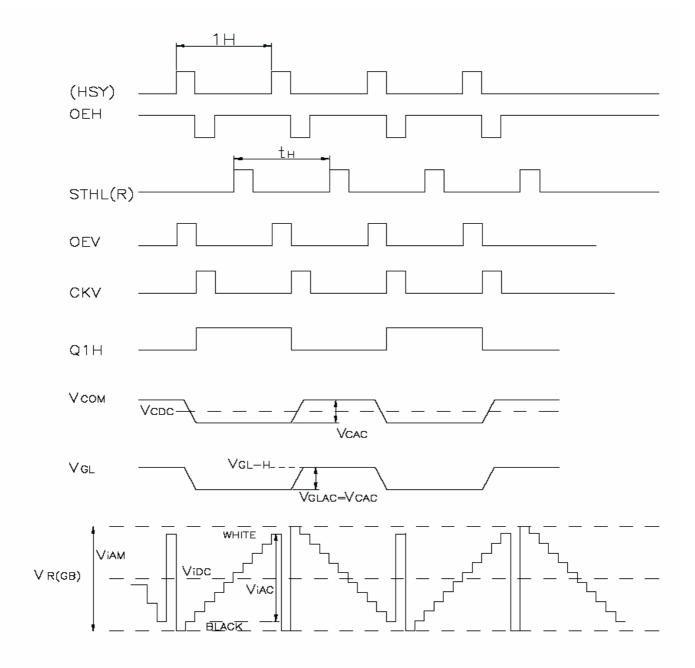
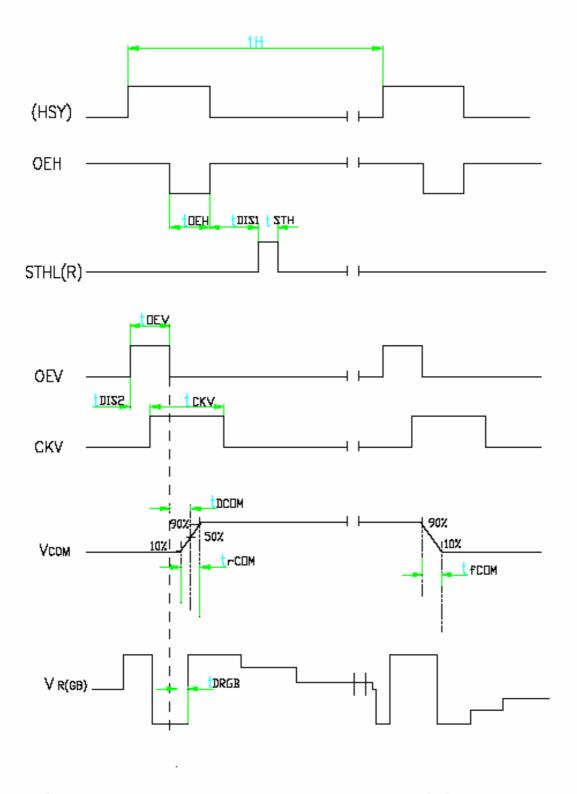


Fig.3-(a) Horizontal timing



Note: The falling edge of OEV should be synchronized with the falling edge of OEH Fig.3-3-(b) Detail horizontal timing

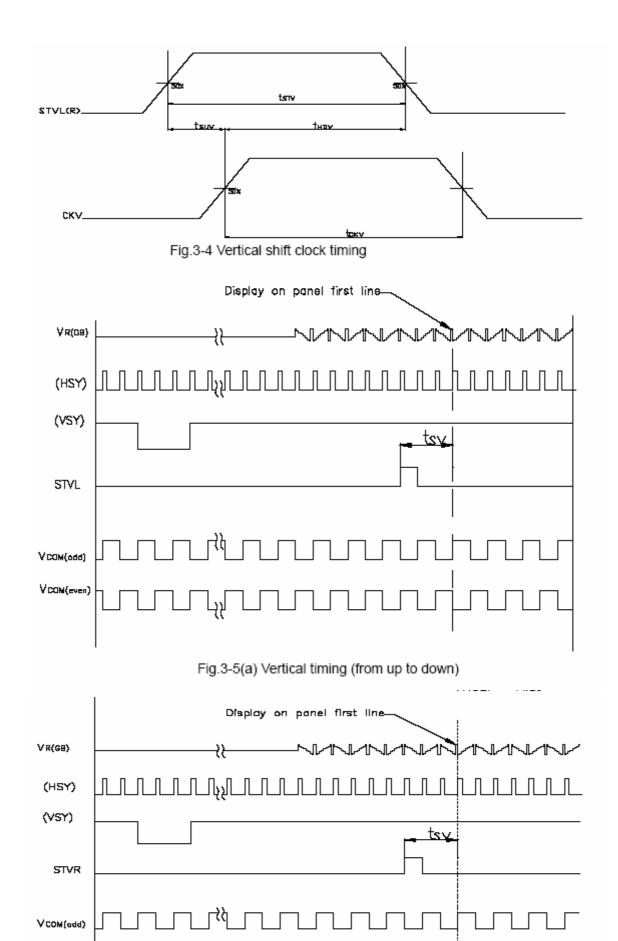


Fig.3-5(b) Vertical timing (from down to up)

V con(even)

10.Reliability

Content of Reliability Test (wide temperature, -30°C~70°C)

Environmental Test			
Test Item	Content of Test	Test Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80℃ 200hrs	2
Low Temperature storage	Endurance test applying the high storage temperature for a long time.	-30°C 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	80°C 200hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-30°C 200hrs	1
High Temperature/ Humidity Operation	The module should be allowed to stand at 60°C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -30°C 25°C 80°C 30min 5min 30min 1 cycle	-30°C/80°C 10 cycles	
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 15mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5k Ω CS=100pF 1 time	

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

Note3: Vibration test will be conducted to the product itself without putting it in a container.

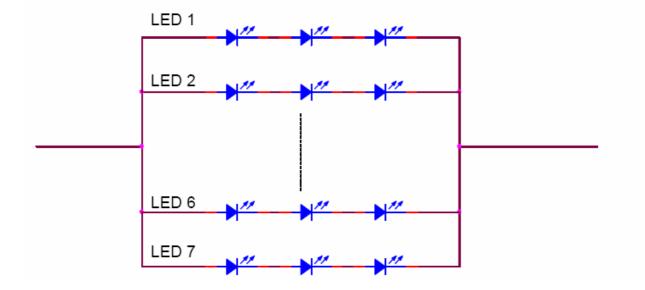
11. Backlight Information

Specification

Item	Cumbal	Values			Unit	Remark	
iteiii	Symbol	Min.	Тур.	Max.	Unit	Remark	
LED voltage	V _L	-	9.9	10.5	V	Note 2	
LED current	IL	-	20	-	mA	Note 2	
LED life time	-	20,000	-	-	Hr	Note 1	

Note 1: The "LED life time" is defined as the module brightness decrease to 50% original brightness that the ambient temperature is 25°C and I_L =20mA.

Note 2: The LED driving condition is defined for each LED module.(3 LED Serial)



12. <u>Inspection specification</u>

NO	Item	Criterion			
01	Electrical Testing	 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect. 			
02	Black or white spots on LCD (display only)	 2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm 			
03	LCD black spots, white spots, contamination (non-display)	3.1 Round type : As following drawing $\Phi = (x + y)/2$ X $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$ 3.2 Line type : (As following drawing) $C = (As following drawing)$ $C = $	2.5		
		$\begin{array}{c ccccccccccccccccccccccccccccccccccc$			
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction. $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$			

NO	Item	Criterion	AQL
		Symbols: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length L: Electrode pad length 6.2 Protrusion over terminal: 6.2.1 Chip on electrode pad:	
		$\begin{array}{ c c c c c c }\hline y: Chip \ width & x: Chip \ length & z: Chip \ thickness \\\hline y \le 0.5mm & x \le 1/8a & 0 < z \le t \\\hline 6.2.2 \ Non-conductive \ portion: \\ \hline L & L & L \\\hline \end{array}$	
06	Glass	y: Chip width x: Chip length z: Chip thickness	2.5
		 y≤ L x≤1/8a 0 < z≤ t ⊙ If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications. ⊙ If the product will be heat sealed by the customer, the alignment mark not be damaged. 6.2.3 Substrate protuberance and internal crack. v: width x: length	

NO	Item	Criterion		
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5	
08	Backlight elements	 8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong. 	0.65 2.5 0.65	
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.9.2 Bezel must comply with job specifications.	2.5 0.65	
10	РСВ, СОВ	 10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down. 	2.5 2.5 0.65 2.5 2.5 0.65 2.5	
11	Soldering	 11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB. 	2.5 2.5 2.5 0.65	

NO	Item	Criterion	AQL
12	General appearance	 12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP. 12.2 No cracks on interface pin (OLB) of TCP. 12.3 No contamination, solder residue or solder balls on product. 12.4 The IC on the TCP may not be damaged, circuits. 12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever. 12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color. 12.7 Sealant on top of the ITO circuit has not hardened. 12.8 Pin type must match type in specification sheet. 12.9 LCD pin loose or missing pins. 12.10 Product packaging must the same as specified on packaging specification sheet. 12.11 Product dimension and structure must conform to product specification sheet. 	2.5 0.65 2.5 2.5 2.5 2.5 0.65 0.65 0.65 0.65



LCM Sample Estimate Feedback Sheet winstar **Module Number:** Page: 1 1. Panel Specification: □ NG ,_____ 1. Panel Type: Pass 2. View Direction: Pass \square NG,_____ 3. Numbers of Dots: □ NG ,_____ Pass 4. View Area: ☐ Pass \square NG. ☐ NG ,_____ 5. Active Area: Pass 6. Operating Temperature: Pass \square NG, □ NG ,____ 7. Storage Temperature: Pass 8. Others: 2. Mechanical Specification: 1. PCB Size: Pass □ NG, 2. Frame Size: ☐ Pass \bigcap NG, 3. Material of Frame: ☐ Pass ☐ NG ,_____ 4. Connector Position: ☐ NG ,_____ Pass 5. Fix Hole Position: □ NG ,_____ Pass 6. Backlight Position: ☐ Pass \bigcap NG. 7. Thickness of PCB: ☐ Pass ☐ NG ,_____ 8. Height of Frame to PCB: Pass □ NG ,_____ ☐ NG ,_____ 9. Height of Module: Pass 10. Others: \bigcap NG, Pass 3. Relative Hole Size: 1. Pitch of Connector: Pass □ NG ,_____ 2. Hole size of Connector: ☐ Pass □ NG ,_____ 3. Mounting Hole size: ☐ Pass □ NG, ☐ Pass □ NG ,_____ 4. Mounting Hole Type: 5. Others: Pass \square NG, 4. Backlight Specification: 1. B/L Type: □ NG, Pass 2. B/L Color: Pass \square NG, ☐ NG ,_____ 3. B/L Driving Voltage (Reference for LED Type): Pass \bigcap NG, 4. B/L Driving Current: ☐ Pass

NG, >> Go to page 2 <<

☐ NG ,_____ ☐ NG ,_____

Pass

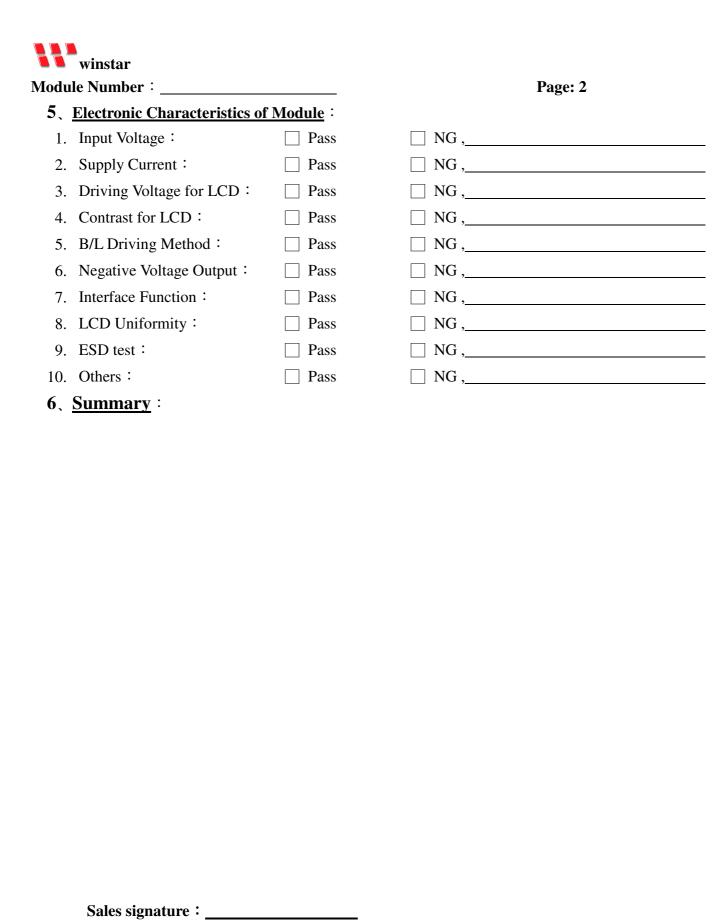
Pass

☐ Pass

5. Brightness of B/L:

6. B/L Solder Method:

7. Others:



Customer Signature :

Date: / /